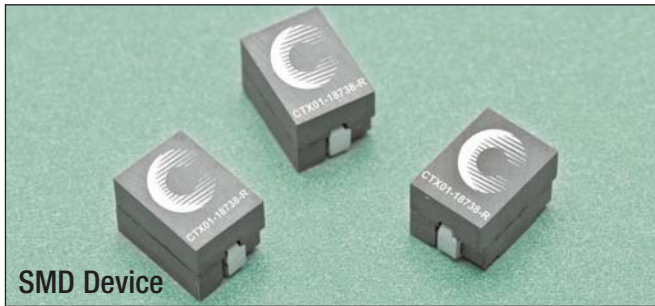


High Current, High Frequency Power Inductors

Flat-Pac™ CTX01-18738-R



Description

- Halogen free, lead free, RoHS compliant
- 125°C Maximum total temperature operation
- 11 x 8.0 x 7.5mm Maximum surface mount package
- High current carrying capacity, low core losses
- Controlled DCR tolerance for sensing circuits
- Frequency range up to 2MHz

Applications

- Voltage Regulator Module (VRM)
- Multi-phase regulators
- Point-of-load modules
- Desktop and server VRMs and EVRDs
- Base station equipment
- Battery power systems
- Graphics cards
- Data networking and storage systems

Environmental Data

- Storage temperature range: -40°C to +125°C
- Operating temperature range: -40°C to +125°C (ambient plus self-temperature rise)
- Solder reflow temperature: J-STD-020D compliant

Packaging

- Supplied in tape and reel packaging, 500 parts per 13" diameter reel

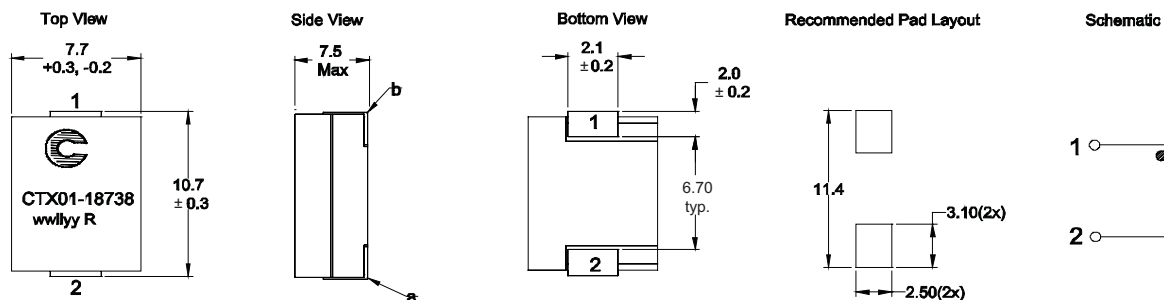
Product Specifications

Part Number ⁶	OCL ¹ ± 10% (nH)	FLL ² Min (nH)	I _{rms} ³ (Amps)	I _{sat} 1 ⁴ @25°C (Amps)	I _{sat} 2 ⁵ @125°C (Amps)	DCR (mΩ) @20°C
CTX01-18738-R	210.0	151.0	50	55.0	45.0	0.29 ± 5%

1. Open Circuit Inductance (OCL) Test Parameters: 300kHz, 0.10Vrms, 0.0Adc @ 25°C.
2. Full Load Inductance (FLL) Test Parameters: 300kHz, 0.10Vrms, I_{sat}1 @ 25°C.
3. I_{rms}: DC current for an approximate temperature rise of 20°C without core loss. Derating is necessary for AC currents. PCB layout, trace thickness and width, air-flow and proximity of other heat generating components will affect the temperature rise. It is recommended that the temperature of the part not exceed 125°C under worst case operating conditions verified in the end application.

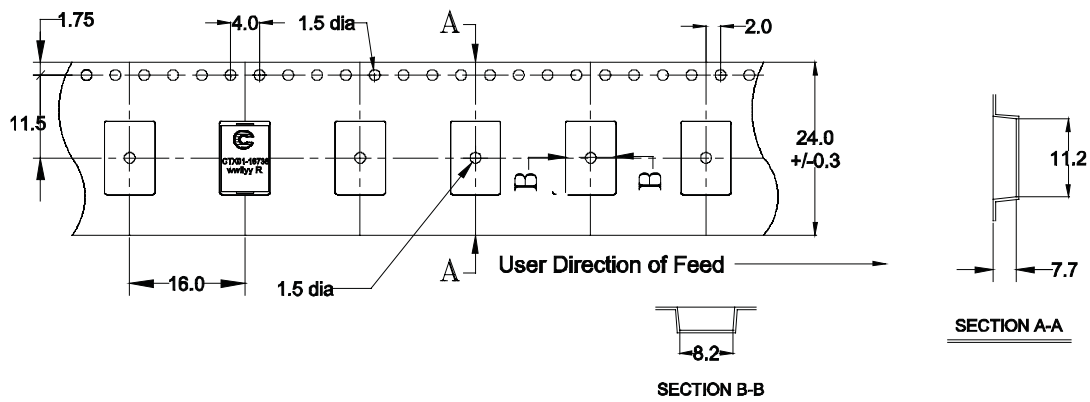
4. I_{sat}1: Peak current for approximately 20% rolloff at +25°C.
5. I_{sat}2: Peak current for approximately 20% rolloff at +125°C.
6. Part Number Definition: CTX01-18738-R
 - CTX01-18738 = Product code and size
 - "R" suffix = RoHS compliant

Dimensions - mm



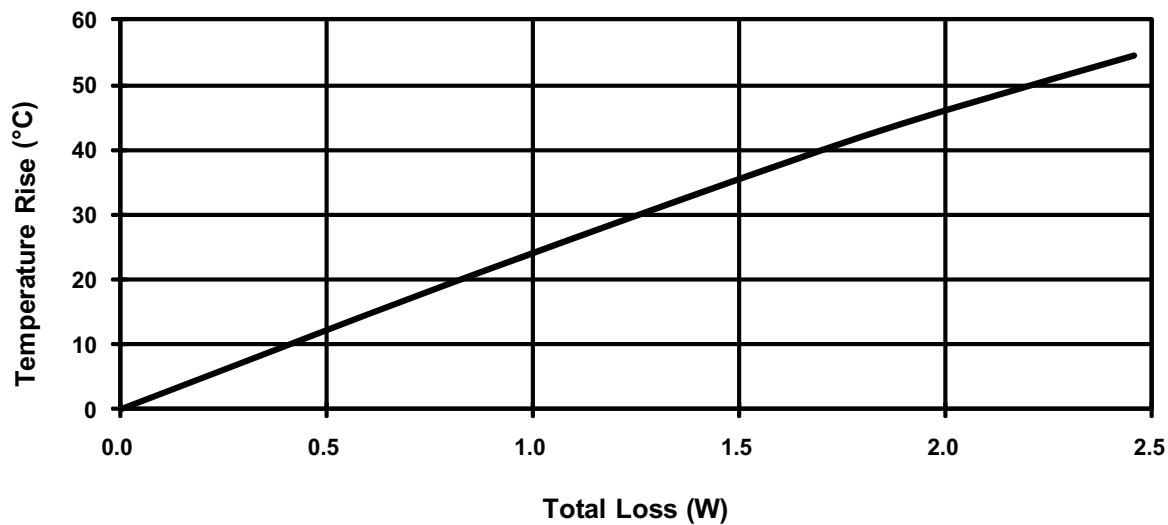
Part marking: Coiltronics logo CTX01-18738 wwilly= Date Code R= Revision Level
 All soldering surfaces must be coplanar within 0.102 millimeters.
 Tolerances are +/-0.1 millimeters unless stated otherwise

Packaging Information - mm

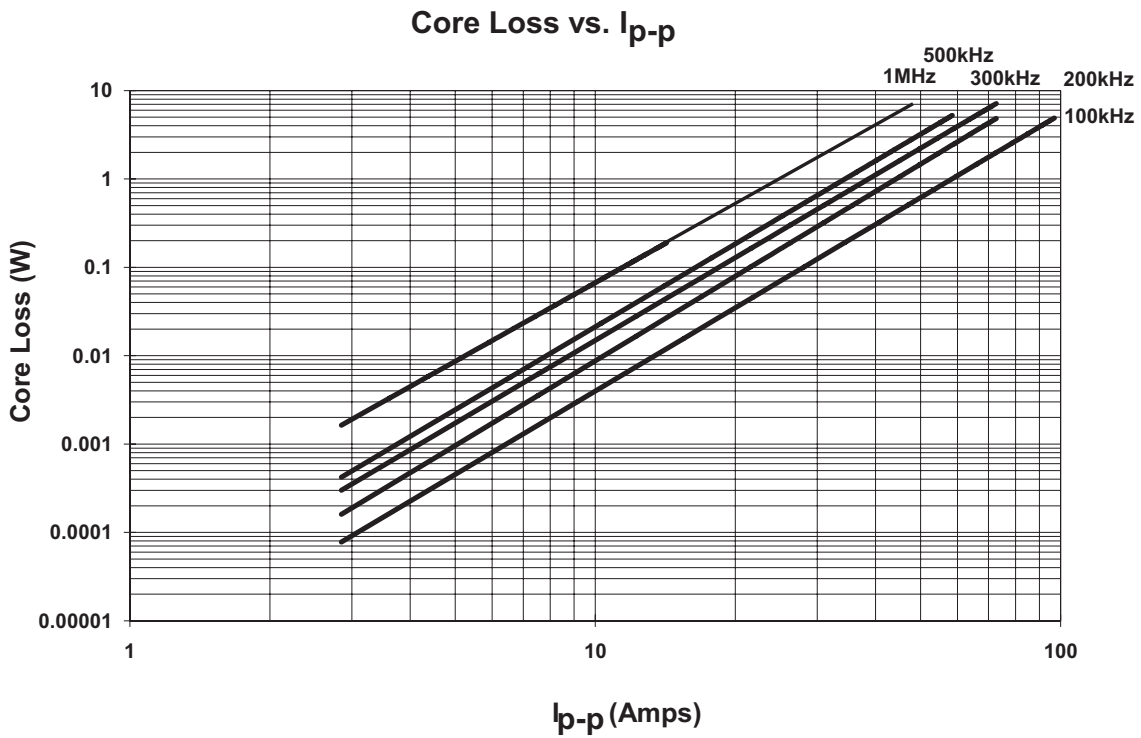


Supplied in tape and reel packaging, 500 parts per 13" diameter reel.

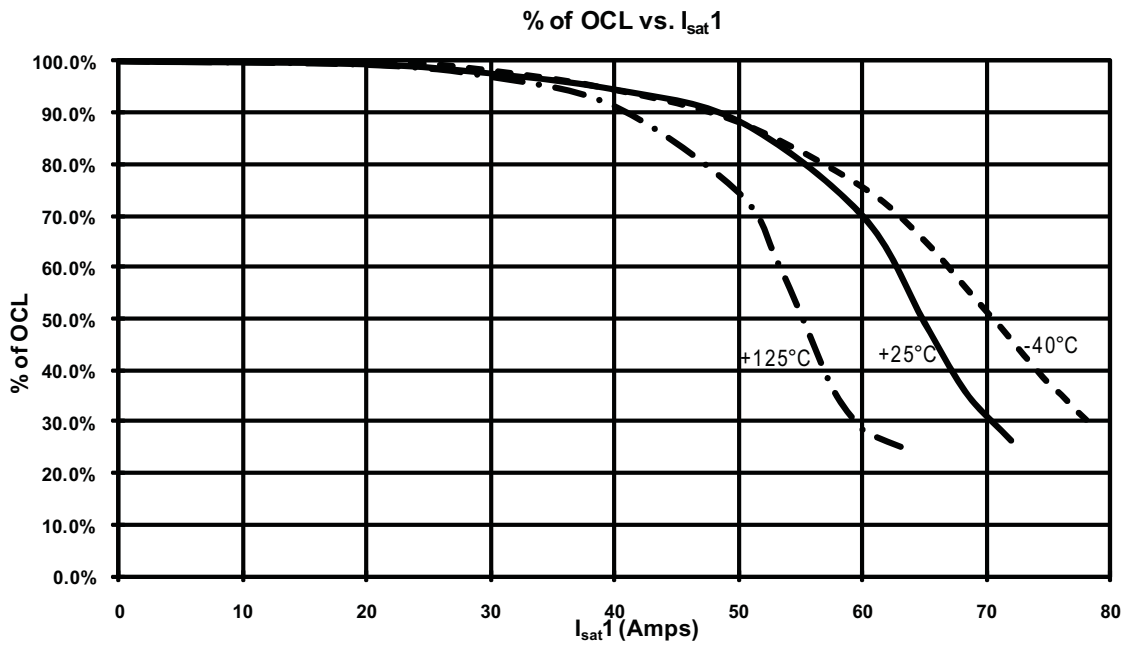
Temperature Rise vs. Total Loss



Core Loss



Inductance Characteristics



Solder Reflow Profile

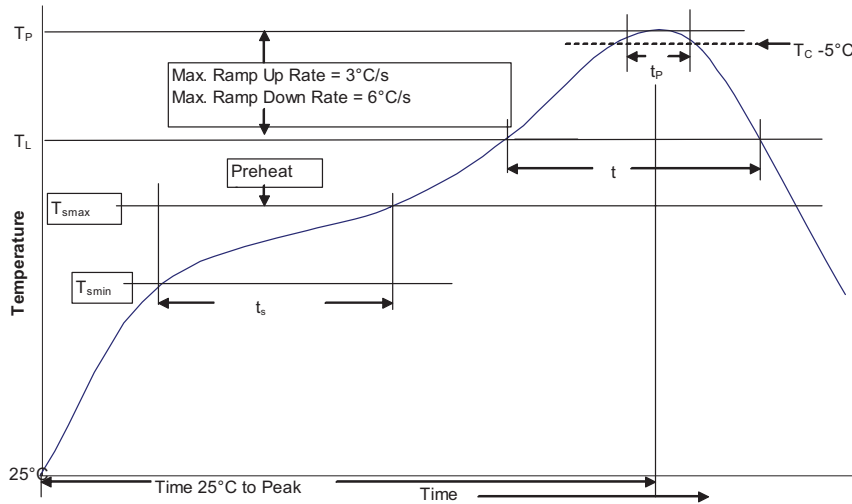


Table 1 - Standard SnPb Solder (T_C)

Package Thickness	Volume mm^3 <350	Volume mm^3 ≥ 350
<2.5mm	235°C	220°C
$\geq 2.5mm$	220°C	220°C

Table 2 - Lead (Pb) Free Solder (T_C)

Package Thickness	Volume mm^3 <350	Volume mm^3 350 - 2000	Volume mm^3 >2000
<1.6mm	260°C	260°C	260°C
1.6 - 2.5mm	260°C	250°C	245°C
>2.5mm	250°C	245°C	245°C

Reference JDEC J-STD-020D

Profile Feature	Standard SnPb Solder	Lead (Pb) Free Solder
Preheat and Soak		
• Temperature min. (T_{smin})	100°C	150°C
• Temperature max. (T_{smax})	150°C	200°C
• Time (T_{smin} to T_{smax}) (t_s)	60-120 Seconds	60-120 Seconds
Average ramp up rate T_{smax} to T_P	3°C/ Second Max.	3°C/ Second Max.
Liquidous temperature (T_L)	183°C	217°C
Time at liquidous (t_L)	60-150 Seconds	60-150 Seconds
Peak package body temperature (T_P)*	Table 1	Table 2
Time (t_p)** within 5 °C of the specified classification temperature (T_C)	20 Seconds**	30 Seconds**
Average ramp-down rate (T_P to T_{smax})	6°C/ Second Max.	6°C/ Second Max.
Time 25°C to Peak Temperature	6 Minutes Max.	8 Minutes Max.

* Tolerance for peak profile temperature (T_P) is defined as a supplier minimum and a user maximum.

** Tolerance for time at peak profile temperature (t_p) is defined as a supplier minimum and a user maximum.

North America

Cooper Electronic Technologies
1225 Broken Sound Parkway NW
Suite F
Boca Raton, FL 33487-3533
Tel: 1-561-998-4100
Fax: 1-561-241-6640
Toll Free: 1-888-414-2645

Cooper Bussmann
P.O. Box 14460
St. Louis, MO 63178-4460
Tel: 1-636-394-2877
Fax: 1-636-527-1607

Europe

Cooper Electronic Technologies
Cooper (UK) Limited
Burton-on-the-Wolds
Leicestershire • LE12 5TH UK
Tel: +44 (0) 1509 882 737
Fax: +44 (0) 1509 882 786

Cooper Electronic Technologies
Avda. Santa Eulalia, 290
08223
Terrassa, (Barcelona), Spain
Tel: +34 937 362 812
+34 937 362 813
Fax: +34 937 362 719

Asia Pacific

Cooper Electronic Technologies
1 Jalan Kilang Timor
#06-01 Pacific Tech Centre
Singapore 159303
Tel: +65 278 6151
Fax: +65 270 4160

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